

IN COOPERATION WITH



13TH FRAUNHOFER SYMPOSIUM IN SENDAI APRIL 15TH, 2019 | SAKURA HALL

## SMART SOCIETY 5.0 AND INDUSTRY 4.0



## **AGENDA**

9:20 a.m.	Opening Address	1:40 p.m.	Three-Dimensional Shape Measurement using
	Hideya Miki, Fraunhofer Repesentative Office Japan		Multi-Channel VCSEL Array
09:30 a.m.	Welcome		Tatsuya Shimokawa, Suguru Sangu, Ricoh
	Prof. Motoko Kotani, Executive Member Science		Company, Ltd.
	Counsel Japan and Director WPI-Advanced Institute	2:10 p.m.	3D-Printing and System Integration of Polymer
	for Materials Research, Tohoku University;		based Optics for Advanced Illumination
	Prof. Masayoshi Esashi, Tohoku University		Applications
			Dr. Erik Beckert, Fraunhofer IOF
9:40 a.m.	Smart Systems for Industry 4.0	2:40 p.m.	Collaboration between Mathematical Science
	Prof. Thomas Otto, Fraunhofer ENAS		and Clinical Medicine
10:10 a.m.	Proposal and Social Implementation of Edge		Prof. Hiroshi Suito, Tohoku University
	Heavy Sensing Framework Based on Micro-	3:10 p.m.	Fraunhofer Lighthouse Project »Theranostic
	technology in the AI Era		Implants« Focus on active implants, MEMS,
	Assoc. Prof. Masanori Muroyama, Tohoku University		Organ on a Chip
10:40 a.m.	Break		Dr. Thomas Velten, Fraunhofer IBMT
		3:40 p.m.	Break
11:10 a.m.	Building Digital Ecosystems: The Industry 4.0		
	Reference Software Platform	4:10 p.m.	Open Collaboration based on Sharing Facility
	Dr. Jens Heidrich, Fraunhofer IESE		for MEMS
11:40 a.m.	Micro/nanomechanical Systems for		Assoc. Prof. Kentaro Totsu, Dr. Masaaki Moriyama,
	Ultrasensitive Sensing		Prof. Masayoshi Esashi, Tohoku University
	Prof. Takahito Ono, Tohoku University	4:40 p.m.	Research Fab Microelectronics Germany
12:10 p.m.	<b>Development of Biodegradable Electronic</b>		Joerg Amelung, FMD
	Components using Printing Technologies	5:10 p.m.	Industry-Relevant Research and Development in
	Dr. Maik Wiemer, Fraunhofer ENAS		S. Tanaka Laboratory
12:40 p.m.	Lunch break		Prof. Shuji Tanaka, Tohoku University
		6:00 p.m.	Reception

## REGISTRATION

Phone

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Symposium	Lunch	Reception			
(Lunch buffet and reception are free of charge.)					
Contact details					
Mr.	Mrs.				
Name, Surname					
Affiliation					
Address (Street, ZIP, C	City, Country)				
E-Mail					

The Fraunhofer Symposium is held in cooperation with Tohoku University and takes place in the Sakura Hall www.tohoku.ac.jp/en/about/facilities/conferences\_events/214\_sakura\_hall.html It is organized by Fraunhofer ENAS (Germany) in cooperation with the Fraunhofer Project Center »NEMS/MEMS devices and manufacturing technologies at Tohoku University«, the Fraunhofer Representative Office Japan in Tokyo and the Micro System Integration Center, Tohoku University.